

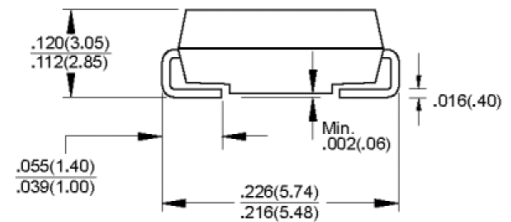
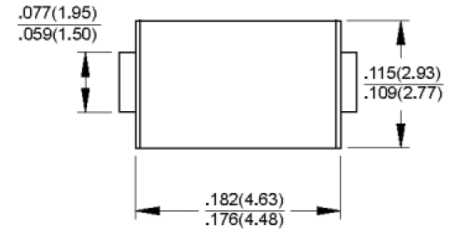
Features

- ◆ Ideal for surface mounted applications
- ◆ Metal-Semiconductor junction with guardring
- ◆ Epitaxial construction
- ◆ Low leakage current
- ◆ Metallurgically bonded construction
- ◆ High current capability
- ◆ Plastic material has UL flammability classification 94V-0
- ◆ For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

2018



DO-214AC (SMAJ)



Dimensions in inches and (millimeters)

Mechanical Data

- ◆ Case : New SMA molded plastic
- ◆ Polarity : Indicated by cathode band
- ◆ Weight : 0.004 ounce, 0.11 gram

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Parameter	Symbols	SK 12-S	SK 13-S	SK 14-S	SK 15-S	SK 16-S	SK 17-S	SK 18-S	SK 19-S	SK 1B-S	Units	
Maximum repetitive peak reverse voltage	V _{RRM}	20	30	40	50	60	70	80	90	100	Volts	
Maximum RMS voltage	V _{RMS}	14	21	28	35	42	49	56	63	70	Volts	
Maximum DC blocking voltage	V _{DC}	20	30	40	50	60	70	80	90	100	Volts	
Maximum average forward rectified current at derating lead temperature	I _{F(AV)}	1.0									Amp	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	40.0									Amps	
Maximum instantaneous forward voltage at 1.0A DC	V _F	0.450	0.550	0.600	0.720			0.800			Volts	
Maximum DC reverse current @ T _A =25°C at rated DC blocking voltage @ T _A =100°C	I _R	0.5					10					mA
Typical thermal resistance (Note 1)	R _{BJA}	50									°C/W	
Typical junction capacitance (Note 2)	C _J	110									pF	
Operating temperature range	T _J	-65 to +125			-65 to +150						°C	
Storage temperature range	T _{STG}	-65 to +150									°C	

- Notes:**
1. Thermal Resistance (Junction to Ambient).
 2. Measured at 1 MHz and applied reverse voltage of 4.0 volts.
 3. P.C.B Mounted with 0.2X0.2" (5.0 X 5.0mm²) copper pad area.

RATINGS AND CHARACTERISTIC CURVES

FIG. 1 - TYPICAL FORWARD CURRENT DERATING CURVE

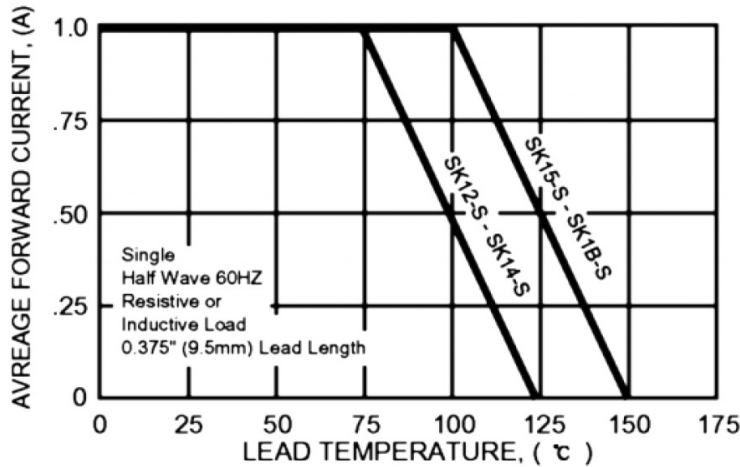


FIG. 2 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

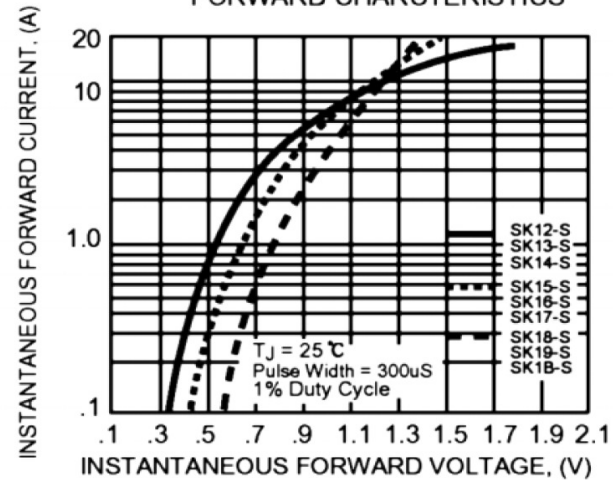


FIG. 3A - TYPICAL REVERSE CHARACTERISTICS

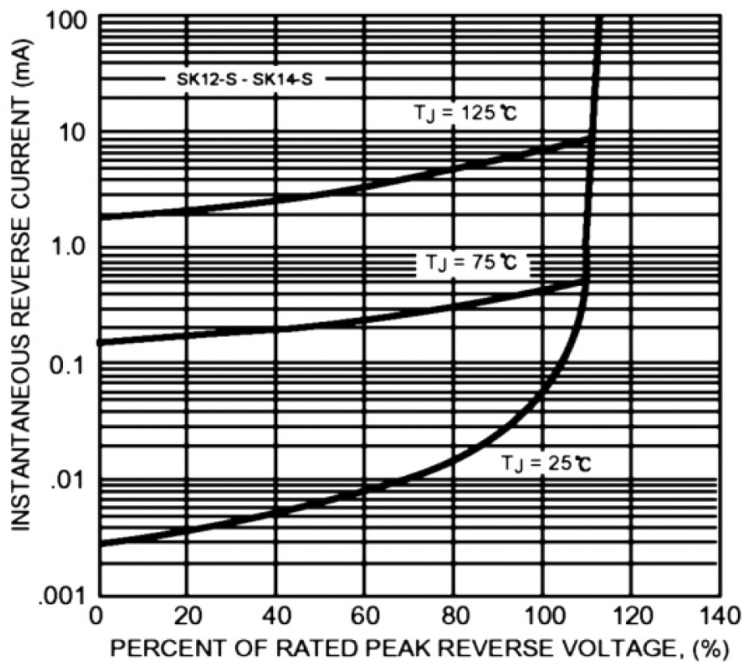


FIG. 3B - TYPICAL REVERSE CHARACTERISTICS

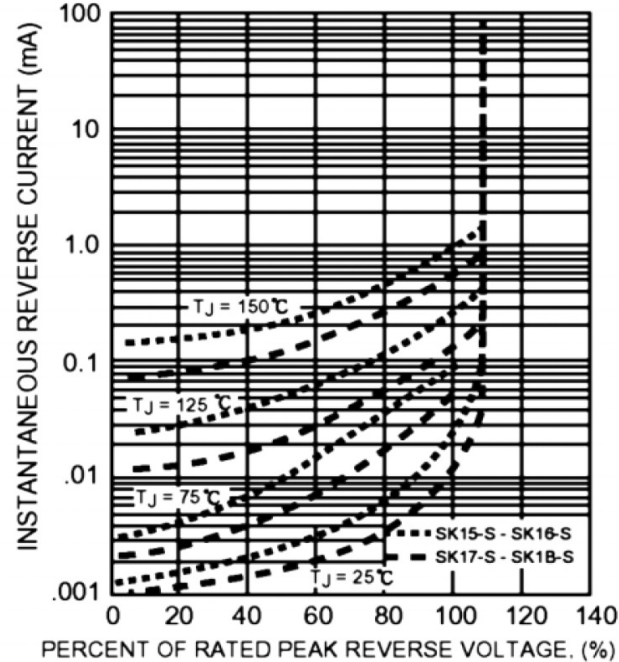


FIG. 4 - MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

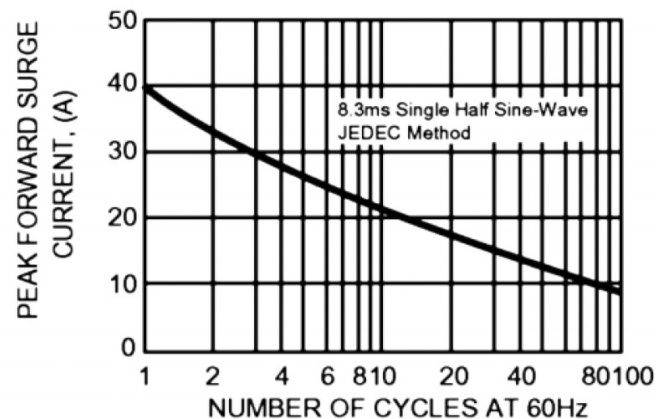


Figure :
New SMA Assembly



Round Lead
Process